AMANA SAMA MANA JOSEPH PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

SU et al.

Serial No.: 09/394,918

Filed: September 13, 1999

For: SUBSTRATE SAWING PROCESS FOR A STRIP

AUG 1 0 2000 W

Group Art Unit: 3724

Examiner: O. Flores Sanchez

6 23 ZUUI JO MAIL RO

<u>AMENDMENT</u>

Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

This is in response to the Official Action of April 11, 2000, in connection with the above-identified application. The period for response to this Official Action has been extended to expire on August 11, 2000, by the filing herewith of a Petition for a one-month extension of time and payment of the required fee.

Please amend the above-identified application as follows.

IN THE SPECIFICATION:

Please cancel the title and add the following new title to the application, -- Process for Sawing Substrate Strip--.

Page 1, line 4, after "sawing process", please cancel "for a strip";

line 5, please cancel "substrate sawing process by the multi-alignment on a strip" and insert - process for sawing a substrate strip having multi-alignment means thereon--;

an